



Microwave Dielectric Properties of Ferroelectric BaTiO₃ Thin Film

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Abstract. The dielectric properties of *c*-axis epitaxial BaTiO₃ thin film on LaAlO₃ are investigated at frequencies of 0.5–30 GHz. For the measurements, interdigital capacitors with the Au/Ti electrode configurations of five fingers pairs that are 15 μm wide and spaced 2 μm apart are prepared by photolithography and lift-off patterning. Finger length varies from 20 to 80 μm. The capacitance of epitaxial BaTiO₃ films exhibited no frequency dependence up to 10 GHz with the exception of slightly upward tendency of capacitance in BaTiO₃ film with a finger length of 80 μm due to the self resonant frequency at 20 GHz. The *Q*-factors of the capacitors, defined as $Q = 1/\omega CR$, are decreased up to 10 GHz with increased frequency. At 10 GHz, the BaTiO₃ film has a tunability [defined as $k(V) = [C(0) - C(V)]C(0)$] of 1.5% at 15 V, a loss tangent of ≤ 0.2 at room temperature. The small tunability can be interpreted as a result of in-plane compressive stress of BaTiO₃ film exhibiting large dielectric anisotropy. For the improvement of tunability and dielectric loss in the interdigital BaTiO₃ capacitor, the tetragonality (*c/a*) of epitaxial BaTiO₃ film and design of interdigital capacitor should be modified.

Keywords: microwave, dielectric, epitaxial, BaTiO₃, polar phase

1. Introduction

Ferroelectric perovskite-type oxide thin films such as Ba_xSr_{1-x}TiO₃ and SrTiO₃ have been intensively investigated for microwave and millimeter-wave applications because of their large nonlinear dielectric property which is defined as the strong dependence of permittivity on electric field. As candidate materials for microwave applications, ferroelectrics of a paraelectric phase have been mainly considered because ferroelectric materials which are in polar phase at room temperature can give rise to additional dielectric loss due to domain-wall motion [1, 2] and the shear sound waves excited by ferroelastic domain walls or piezoelectric domain effect [3]. Also, the intrinsic hysteresis, which appears in *DC* bias dependence of the capacitance, can impede the application of ferroelectric materials in a polar phase. However, Powles and Jackson [4] observed that the center of the relaxation spectrum by domain-wall motion appears to be at about 3×10^9 Hz and it was investigated by Arlt et al.

[3, 5] that relaxation frequency by piezoelectric domains is about 2×10^9 Hz. Therefore, the domain movement and the sound generation excited by piezoelectric effect do not contribute to microwave loss at frequency more than 10 GHz. Also, Boikov et al. [6] reported for the epitaxial SrRuO₃/BaTiO₃/SrRuO₃ film structure that *Q*-factor related to the hysteresis phenomena and tunability of *C-V* curve can be optimized through the variation of *c/a* ratio. Moreover, recent studies [7, 8] demonstrated that the Na_{0.5}K_{0.5}NbO₃ ferroelectric thin film in a polar phase at room temperature shows the tunability of 13%, high *Q*-factor ($1/\tan\delta$) = 15–80 at 40 GHz. Nevertheless, little has been published regarding the tunability and *Q*-factor of ferroelectric materials in a polar phase at microwave frequency range. In this article, the dielectric properties of epitaxial BaTiO₃ thin film, which is typical ferroelectric materials with tetragonally distorted perovskite structure at room temperature, was investigated in microwave frequency range of 0.5–30 GHz.

2. Experimental Details

The epitaxial BaTiO₃ thin films with 500 nm thickness were deposited on a wafer of (001) single crystal lanthanum aluminate by *RF* magnetron sputtering system operated at a base pressure of about 1×10^{-6} torr. The sputtering was carried out under the working pressure of 10 mtorr using a gas mixture of Ar/O₂ (4:1). An applied *RF* power was 120 W and the substrate temperature was kept at 600°C. Prior to deposition, the target was sputter cleaned during 30 minutes. An array of interdigital capacitors was fabricated on epitaxial BaTiO₃ film by photolithography and Au/Ti (80 nm/20 nm) lift-off patterning. The interdigital capacitors have 5 finger pairs with a finger width of 15 μm and a gap of 2 μm. The finger lengths are 20, 40 and 80 μm. The devices were connected via ground-signal-ground (*GSG*) probe to an *HP* 8510 *C* network analyzer in the frequency band 0.5–30 GHz at room temperature. Two port *S*-parameters measured on interdigital capacitors were converted into admittance (*Y*) parameters. From the relationship $Im(Y) \approx j\omega C$ (where ω is the operating frequency and *C* is capacitance), the capacitance and *Q*-factor were measured through de-embedding procedure in a frequency range which the amplitude of capacitance is not affected by resonant frequency.

3. Results and Discussion

Figure 1 shows X-ray diffraction patterns of BaTiO₃/LaAlO₃ structures. An X-ray diffractometer θ - 2θ scan for the BaTiO₃/LaAlO₃ structure reveals peaks only from the {001} family planes with a full width half maximum (FWHM) of 1.047°. The absence of any other peaks indicates that the BaTiO₃ films are either highly textured or single crystal. Alignment of the film to the substrate was confirmed with pole-figure scan of (110) planes in the BaTiO₃ film. The fourfold symmetry corresponding to the {110} reflections was observed as shown in Fig. 1, indicating that the BaTiO₃ film is single crystal.

Figure 2 shows the frequency dependence of dielectric properties (capacitance and *Q*-factor ($=1/\tan\delta$)) of an interdigital capacitor fabricated on BaTiO₃ film with the finger lengths of 20, 40 and 80 μm. We have observed no or weak frequency dependence of the capacitance in the measured frequency range up to 10 GHz with the exception of a slight increase of capacitance for interdigital capacitor with 80 μm length. This upward tendency of capacitance was originated from the result of *LC*-resonance at 20 GHz, induced by parasitic inductance (*L*). The expected dielectric relaxation of epitaxial BaTiO₃ film wasn't observed over

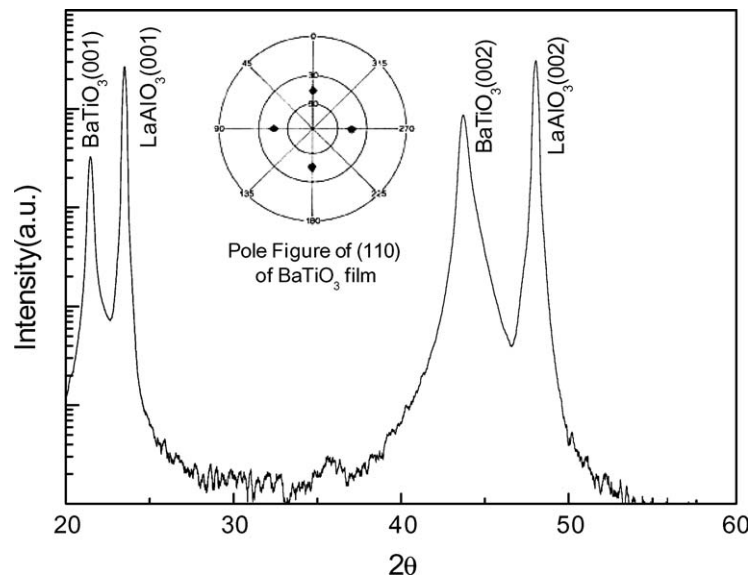


Fig. 1. A typical XRD θ - 2θ pattern of BaTiO₃ thin film grown on a LaAlO₃(100) substrate. The inset shows the pole figure of (110) plane of BaTiO₃ film.

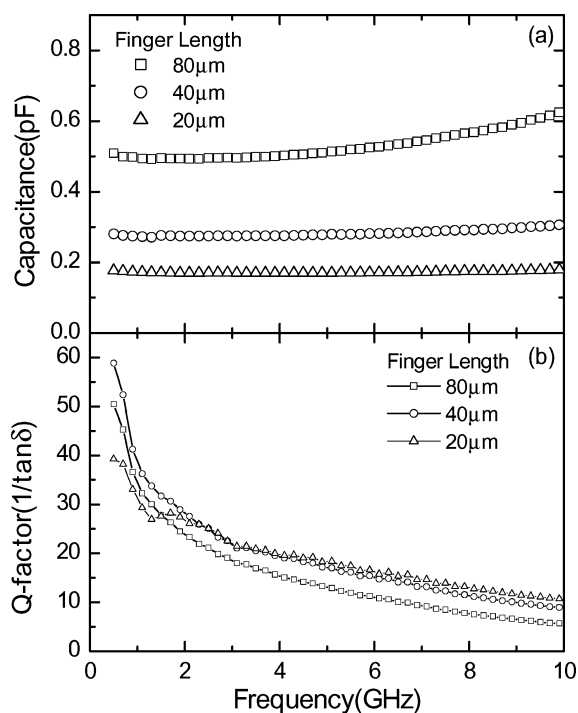


Fig. 2. The frequency dependence of microwave properties measured in interdigital capacitor fabricated on BaTiO₃ film, (a) capacitance and (b) Q-factor.

the measured frequency range because in-plane high compressive stress might induce the shift of relaxation frequency and the exact measurement of frequency dependence of capacitance could be interfered with LC

resonance at 20 GHz. evidently, this LC resonance and the quite thin top electrode actually affected dielectric microwave loss. So, it is considered in this work that most of the measured loss tangent was originated from the effect of electrode structure related to its small electrode-thickness and inductance rather than that of the intrinsic dielectric loss (dielectric relaxation) mechanisms.

Figure 3 shows the measured capacitance (C/C_{max}) that is normalized and loss tangent as a function of DC bias voltage, taken at 10 GHz from interdigital capacitors fabricated on BaTiO₃/LaAlO₃ structure. The tunability, $k(V)$, was calculated by using the equation, $k(V) = [C(0) - C(V)]/C(0)$, where $C(0)$ and $C(V)$ represent the capacitance at zero and a certain dc bias voltage, respectively. The tunability k (15 V) reaches ~1.5% with a loss of ≤ 0.2 at room temperature. The small tunability can be interpreted as a result of in-plane compressive stress of BaTiO₃ film exhibiting large dielectric anisotropy. Hyun et al. [9] reported that the in-plane compressive stress in the BST film with an interdigital electrode decrease the ionic displacement along the electric field parallel to substrate and large tunability should exist near the electrode where the electric field is normal to the substrate since the BST film has distorted tetragonal structure with c/a of 1.009 by in-plane compressive stress. In this work, the measured c/a ratio of epitaxial BaTiO₃ film was 1.04. This result indicates that the epitaxial BaTiO₃ film on LaAlO₃ was under compressive strain and had highly distorted tetragonal unit cell with a c -axis normal to

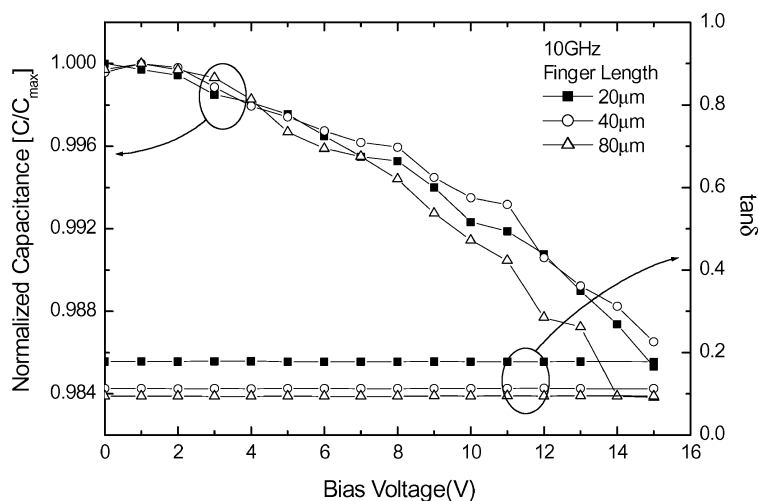


Fig. 3. The capacitance and loss tangent as a function of bias voltage measured in interdigital capacitors fabricated on epitaxial BaTiO₃ film with the various finger lengths. The measuring frequency is 10 GHz.

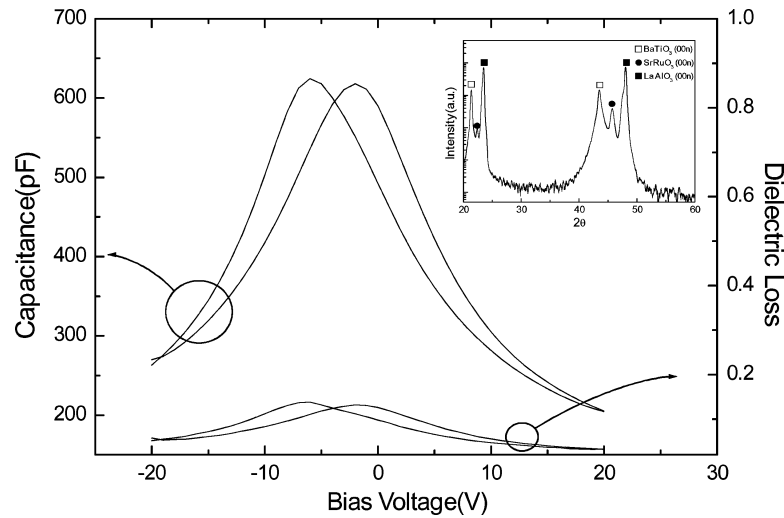


Fig. 4. The capacitance and loss tangent as a function of bias voltage measured in Pt/BaTiO₃/SrRuO₃ parallel capacitors at 1 MHz. The left inset shows XRD θ - 2θ scan for the parallel BaTiO₃ capacitor.

the substrate plane. Moreover, it was assumed that the BaTiO₃ film under in-plane compressive stress shows tunability only along c -axis perpendicular to the substrate. However, it has been reported that the dielectric constant, ϵ_{33} , of BaTiO₃ single crystal along c -axis is much smaller than ϵ_{11} and ϵ_{22} along the a -axis [10] and the lattice elongation along c -axis by high compressive stress in BaTiO₃ crystal can lead to a further decrease of the dielectric responses [11, 12]. Also, Boikov et al. [6] reported that a -axis oriented epitaxial BaTiO₃ film with c/a of 1.007 have a larger permittivity than c -axis one while the c -axis oriented one should have the largest remnant polarization.

To make sure that the small tunability of interdigital BaTiO₃ capacitor can be obtained due to the anisotropic tuning behavior by in-plane stress, parallel capacitor [Pt/BaTiO₃ (240 nm)/SrRuO₃ (100 nm)/LaAlO₃] was fabricated and low frequency characterization (1 MHz) was done by recording the capacitance and dielectric loss as a function of the applied bias. As shown in Fig. 4, there were only (00n) BaTiO₃, (00n) SrRuO₃ and (00n) LaAlO₃ peaks in the X-ray θ - 2θ scan and the measured FWHM of the (00n) BaTiO₃ film was 1.08°. The tunability k (15 V) of parallel BaTiO₃ capacitor at 1 MHz is about 48%, which is much larger than that of interdigital BaTiO₃ capacitor. It is considered that this high tunability is originated from removal of possibility of an anisotropic tuning as well as the increased effective strength of DC electric field due to the small distance

between the top and bottom electrode of parallel capacitor.

Therefore, it is ultimately needed to optimize the Q -factor (defined as tunability/dielectric loss) of interdigital BaTiO₃ capacitor through the variation of c/a ratio in epitaxial BaTiO₃ as well as the increase of Au electrode and BaTiO₃ thickness. The effect of chemical composition on the small tunability was excluded since the stoichiometry of the film agreed well with that of bulk BaTiO₃ crystal.

4. Conclusions

We observed the microwave dielectric properties of epitaxial ferroelectric BaTiO₃ films grown on (001) LaAlO₃ single crystal. The BaTiO₃ film with Au/Ti interdigital electrode shows little frequency dependence of capacitance up to 10 GHz although the capacitance of a BaTiO₃ film with a finger length of 80 μ m slightly increases as a function of frequency because of self-resonance of this capacitor at 20 GHz. The Q -factors of the capacitors are decreased up to 10 GHz as a measuring frequency increases. The BaTiO₃ film had a tunability of 1.5% with loss tangent ≤ 0.2 at 10 GHz. It is assumed that the small tunability may be due to in-plane compressive strain. To eliminate the anisotropic tuning behavior and manipulate of hysteresis in tunability for the interdigital BaTiO₃ capacitor, c/a ratio of epitaxial BaTiO₃ film should be modified. For the improvement of microwave dielectric loss and investigation of

exact frequency dependence of capacitance, a new design of interdigital electrode with thick Au/Ti layer is required.

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